



Specification:

1. Electrical Characteristics:
 - Contact Current Rating: 0.5 Amperes.
 - Dielectric Withstanding Voltage: AC500V r.m.s.
 - Insulation Resistance: 1000 MΩ Minimum.
 - Contact Resistance: 40 mΩ Maximum.
2. Environmental:
 - Operating Temperature: -25°C ~ +90°C.
3. Environmental:
 - Mating Cycles: 5,000 Insertions.
4. Mechanical Characteristics:
 - Card Push Insertion/Out Force: 0.2~1.40kgf.
 - Contact Separation Force: 0.20kgf Minimum.
5. Material:
 - Insulator: HI-Temp Plastic UL 94V-0 Rated.
 - Contact: Copper Alloy (t=0.15mm).
 - Shell: Stainless Steel (t=0.15mm).
 - Spring: SWP.
6. ⊗ Make is FAI test Dimension
▼ Make is major test Dimension

MARK	DESCRIPTION	DATE	REVISED	APPROVED	UNSPECIFIED TOLERANCES	DSND	DATE	SCALE: N/A	MODEL TYPE: TF CARD CONN
ΔX					ANGULAR ±5°	DWN	DATE	VIEW:	PART NO.:
ΔX					L ≤ 4 ±0.2	CHKD	DATE	UNIT: mm	DWG NO.:
ΔX					4 < L ≤ 16 ±0.3	APPD	DATE	SIZE: A4	XKTF-015-X
					16 < L ≤ 63 ±0.4	XKB INDUSTRIAL PRECISION CO., LIMITED			WEIGHT
					L > 63 ±0.5				1.0g
									SHEET
									1/1
									REVISION
									A0

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